



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

















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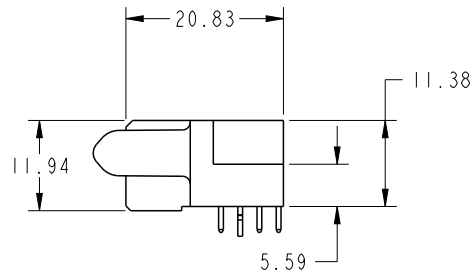
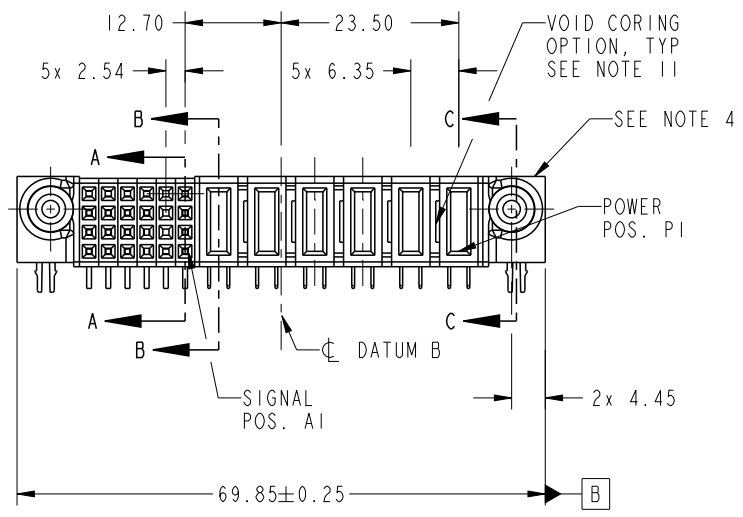
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





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PRODUCT NO.	ROW S	SIGNAL						POWER						E1	
		E2	6	5	4	3	2	1	P6	P5	P4	P3	P2		P1
51772-033-- NOTE 3	D C B A		H	H	H	X	H	H	PA	PA	PA	PA	PA	PA	
			G	G	G	X	G	G							
			F	F	F	X	X	F							
			E	E	E	X	E	E							
															

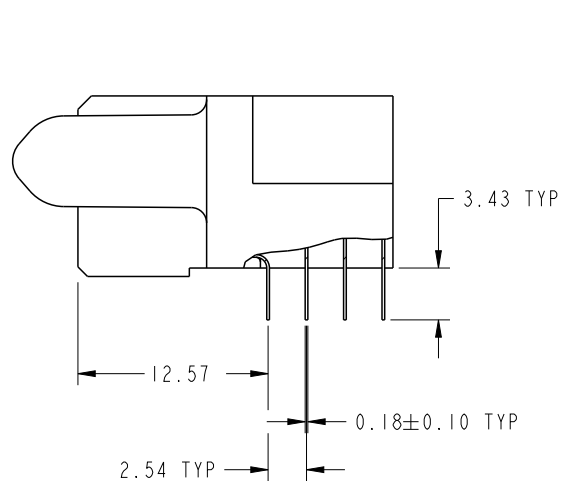


CODE	DIM "M" MATING LENGTH	CONTACT TYPE
PA	[1.07]	POWER
H	[N/A]	SIGNAL
G	[N/A]	SIGNAL
F	[N/A]	SIGNAL
E	[N/A]	SIGNAL
HA	[N/A]	HOLD-DOWN
X	OMITTED	

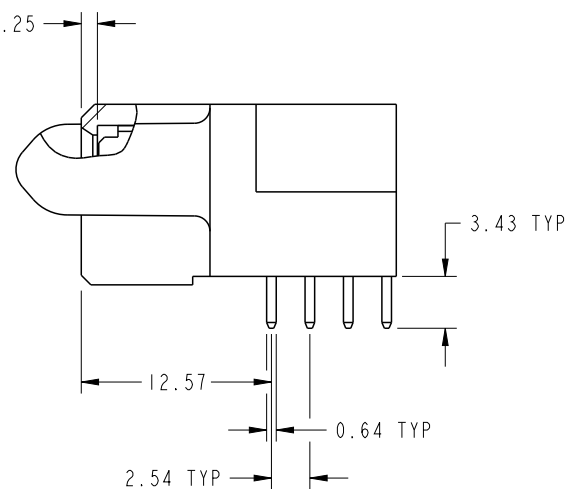
spec ref		SEE NOTES		dr		De-Ming Lu		2014/04/29		projection				size		A4		scale		1:1									
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng		De-Ming Lu		2014/05/06						ecn no		-		rel level		Released									
SEE NOTES				chr		-		-																					
				appr		Pei-Ming Zheng		2014/05/06						product family		PwrBlade													
surface				linear		0.X		±0.50				title		6P + 24S		R/A SOLDER RECEPTACLE		dwg no		51772-033		rev		A					
		angular		0°		±2°		www.fci.com		cat. no.		Product - Customer Drw		sheet 1 of 4															

PRODUCT NUMBER

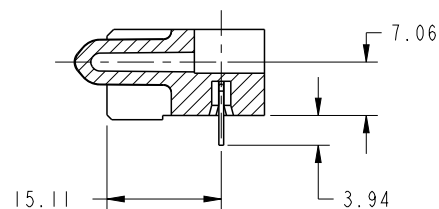
51772-033__
NOTE 3



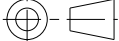


BROKEN-OUT SECTION A-A
SCALE 2:1



BROKEN-OUT SECTION B-B
SCALE 2:1

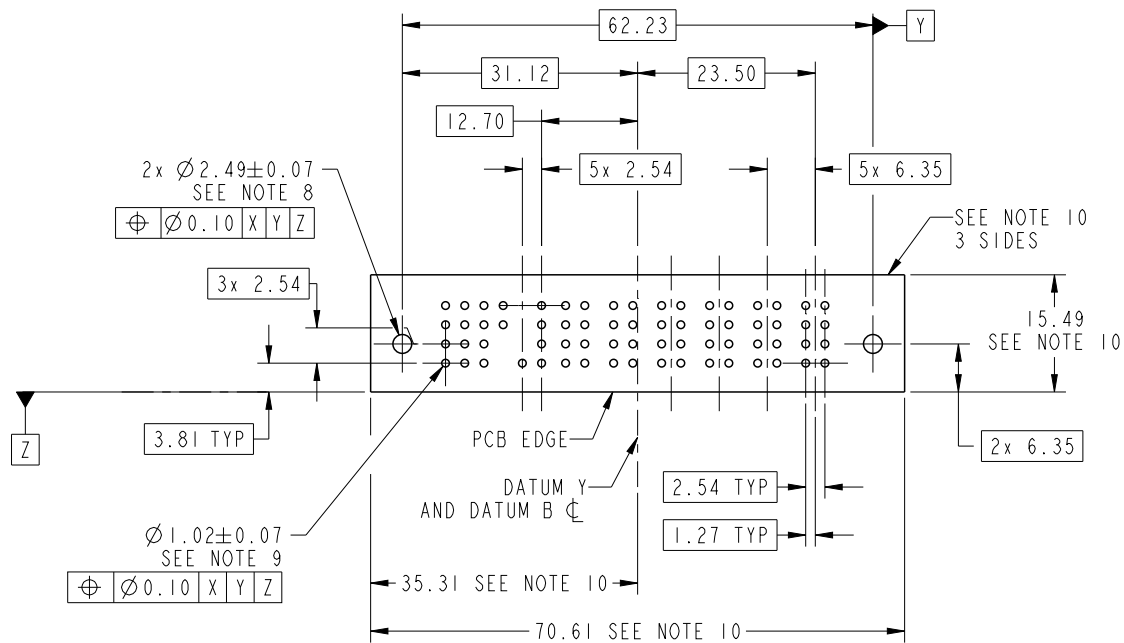


SECTION C-C

dr	De-Ming Lu	2014/04/29	<div>projection</div> <div></div>	<div>MM</div> <div></div>	size	A4	scale	1:1		
eng	De-Ming Lu	2014/05/06			ecn no				-	
chr	-	-			rel level				Released	
appr	Pei-Ming Zheng	2014/05/06	product family		PwrBlade					
	title				6P + 24S			dwg no		rev
www.fci.com		cat. no.			Product - Customer Drw				sheet 2 of 4	

PRODUCT NUMBER

51772-033--
NOTE 3



RECOMMENDED PCB LAYOUT

dr	De-Ming Lu	2014/04/29	<div>projection</div> <div></div>	<div>MM</div> <div></div>	size	A4	scale	1:1	
eng	De-Ming Lu	2014/05/06			ecn no	-			
chr	-	-			rel level	Released			
appr	Pei-Ming Zheng	2014/05/06	product family		PwrBlade				
		title			6P + 24S			rev	
		R/A SOLDER RECEPTACLE			51772-033			A	
www.fci.com		cat. no.			Product - Customer Drw			sheet 3 of 4	



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PRODUCT NUMBER
51772-033__
NOTE 3

NOTES:

1. DIMENSIONS AND TOLERANCES ARE IN ACCORDANCE WITH
ASME Y14.5M, 1994 UNLESS OTHERWISE SPECIFIED.

CONNECTOR NOTES:

2. HOUSING MATERIAL: UL 94 V-0 GLASS FILLED HIGH-TEMP THERMOPLASTIC
POWER CONTACT MATERIAL: COPPER ALLOY
SIGNAL PIN MATERIAL: COPPER ALLOY

3. SEE ITEM 5 & 6 IN PRINT 10064183 FOR PLATING SPEC OF 51772-033 AND 51772-033LF RESPECTIVELY.

4. MANUFACTURER'S NAME, DATE CODE AND OPTIONAL P/N TO APPEAR ON
THIS SURFACE. THE MARK CAN BE OMITTED IF THERE IS NOT ENOUGH SPACE
ON THIS SURFACE.

5. PRODUCT SPECIFICATION GS-12-149.
APPLICATION SPECIFICATION BUS-20-067.

6. PACKAGED IN TRAYS.

PCB NOTES:

7. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE.

8. MOUNTING HOLES, WHERE APPLICABLE, ARE UNPLATED.

9. $\varnothing 1.151 \pm 0.025$ DRILLED HOLES PLATED WITH
0.008 MIN SnPb OR Sn OVER 0.03
TO 0.08 Cu PLATING TO ACHIEVE
 $\varnothing 1.02 \pm .07$ HOLE.

10. CONNECTOR KEEP-OUT ZONE.

11. THE VOID CORING IN BETWEEN POWER MODULES, SIGNAL
MODULES AND END MODULES ARE OPTIONAL AND THE SHAPE
MAY BE DIFFERENT FOR OPTIMIZE THE MOLDING PROCESS. THE
VOID CORING WILL NOT EFFECT TO PRODUCT FUNCTION.

dr	De-Ming Lu	2014/04/29	<div>projection</div> <div></div>	<div>MM</div> <div></div>	size	A4	scale	1:1		
eng	De-Ming Lu	2014/05/06			ecn no -					
chr	-	-								
appr	Pei-Ming Zheng	2014/05/06	product family		PwrBlade		rel level		Released	
<div></div>	title				dwg no				rev	
6P + 24S					51772-033				A	
R/A SOLDER RECEPTACLE										
www.fci.com		cat. no.		Product - Customer Drw				sheet 4 of 4		